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2815
PATENT

Case Docket No. MICRON.170A

Date: April 4, 2002

Page 1

In re application of : Paul A. Farrar)
App. No. : 09/909,181)
Filed : July 19, 2001)
For : METHOD OF USING)
FOAMED INSULATORS IN)
THREE DIMENSIONAL)
MULTIPCHIP STRUCTURES)
Examiner : Chris C. Chu)
Art Unit : 2815)

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Sir:

Transmitted herewith is a Response to Restriction Requirement in the above-identified application.

The fee has been calculated as shown below:

CLAIMS AS FILED

CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	26	—	32	= 0 × \$18	= \$0
Independent Claims	2	—	3	= 0 × \$84	= \$0

If application has been amended to contain multiple
dependent claim(s), then add \$280 = \$0

Time Extension Fee \$0

TOTAL ADDITIONAL FEE
FOR THIS AMENDMENT \$0

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Michael H. Trenholm
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